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Published in:
1st European Microwave Conference

Link to article, DOI:
[10.1109/EUMA.1969.331840](https://doi.org/10.1109/EUMA.1969.331840)

Publication date:
1969

Document Version
Publisher's PDF, also known as Version of record

[Link back to DTU Orbit](#)

Citation (APA):
Jeppesen, P., & Jeppsson, B. (1969). An Analysis of LSA Relaxation Oscillations in GaAs. In *1st European Microwave Conference* (pp. 216-218). IEEE. <https://doi.org/10.1109/EUMA.1969.331840>

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AN ANALYSIS OF LSA RELAXATION OSCILLATIONS IN GaAs.

P. Jeppesen and B. Jeppsson

It has been shown [1] that many times oversized n-GaAs diodes when operated in a high impedance waveguide past structure oscillated in a LSA relaxation mode. It is the purpose of this paper to present a simple analysis of the LSA relaxation mode and to show a new circuit suitable for operation of epitaxial diodes in this mode.

Fig. 1 shows the X-band waveguide iris circuit, consisting of two shorted high impedance parallel plate transmission lines, foreshortened to resonate the device capacitance. In front of the iris is shown two ridge waveguide quarter wavelength transformers for optimization of the diode load impedance. Using epitaxial GaAs, 64 μm thick and doped to $1.8 \times 10^{15} \text{cm}^{-3}$, 45W peak power was obtained in this circuit at 10 GHz with an efficiency of 10%. In a similar K_A-band circuit the same material yielded 25W peak power at 31 GHz with 5% efficiency. In high duty cycle experiments 75 mW average power at 10 GHz and 45 mW at 31 GHz was obtained.

The transmission line equivalent diagram of the waveguide iris circuit is shown in Fig. 2a, along with the circuit parameters. The total diode load impedance is represented by an inductance in parallel with a resistance, Fig. 2b. Both the inductance and the resistance are frequency dependent, their calculated values normalized to the diode low-field impedance shown in Fig. 3.

Using the transmission line circuit of Fig. 2a time-domain computer simulations, including internal diode space charge dynamics, resulted in the steady state diode voltage waveshape shown in Fig. 4. The voltage is normalized to the threshold voltage, V_{TH} .

Design criteria and understanding of the LSA relaxation mode is gained from a simple analysis of the oscillator shown in Fig. 5. The LSA diode is represented by a piecewise linear current voltage characteristic and a total parallel capacitance $C_t = g(f)C_o$, where C_o is the dielectric capacitance of the active layer and $g(f)$ a slightly frequency and voltage dependent factor taking into account the electronic contribution to the total capacitance. The transmission line in Fig. 5 represents the two shorted parallel plate transmission lines forming the iris shown in Fig. 1. This line is foreshortened to resonate the total diode capacitance at the fundamental frequency f , when the following well-known condition is satisfied:

$$\ell \frac{2\pi f}{c} = \tan^{-1} \left[\frac{Y_o}{g(f)C_o 2\pi f} \right] = \tan^{-1} \left[\frac{e\mu_o}{2\pi\epsilon g(f)} \frac{Y_o}{G_o} \frac{n_o}{f} \right] \quad (1)$$

Here c is the velocity of light, e the electronic charge, μ_o the low field mobility, ϵ the permittivity of GaAs, n_o the doping level and G_o the low field conductance. For a typical set of values: $f = 9 \text{ GHz}$, $\mu_o = 8000 \text{ cm}^2/\text{V s}$, $n_o = 1.8 \times 10^{15} \text{ cm}^{-3}$, $Y_o = 0.01 \Omega^{-1}$, $G_o = 0.40 \Omega$ and $g(f) \approx 4$ the transmission line is short enough to be approximated by the inductance

$$L = \frac{1}{Y_o} \frac{\ell}{c} \quad (2)$$

The same approximation in equation (1) also gives

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$$f = \frac{e\mu_o c}{4\pi^2 \epsilon_g(f)} \frac{Y_o}{G_o} \frac{n_o}{f} \frac{1}{L} \quad (3)$$

In agreement with experiments equation (3) shows the dependence of the oscillation frequency on the admittance ratio, the doping to frequency ratio and the length of the transmission line.

The voltage waveshape shown in Fig. 4 can be understood by estimating the time constants involved below and above threshold. Below threshold the device voltage rises approximately according to

$$V(t) = V_B \left[1 - \exp\left(-\frac{t}{\tau_L}\right) \right] \quad (4)$$

where the inductive time constant $\tau_L = G_o L$. From equations (3) and (4) the fraction, t_s/T , of the period spend below threshold is given by

$$\frac{t_s}{T} = \frac{e\mu_o}{4\pi^2 \epsilon_g(f)} \frac{n_o}{f} \ln\left(\frac{V_B}{V_B - V_{TH}}\right) \quad (5)$$

When reaching V_{TH} the device voltage will rise very fast because of the negative differential conductance, G_L . The capacitive time constant for this region of the waveshape is given by

$$\tau_C = \frac{C_t}{G_L - Y_o - G_L} \ll \tau_L \quad (6)$$

The same time constant is applicable when the device voltage decays through the negative conductance region. Further analysis has shown that the portion above threshold only slightly depends on bias voltage and is shorter than the subthreshold portion for moderate bias levels. Therefore, the observed voltage tuneability of the LSA relaxation mode is understood from equation (4).

The fast rise of the device voltage to nearly full amplitude in the first cycle after applying the bias pulse prevents domain formation and thus eliminates fatal avalanching in the starting of long LSA diodes and allows series operation of several such diodes.

In conclusion, for the LSA relaxation oscillator design criteria have been established based on a simple analysis, which is in good agreement with experimental results and with complete computer simulations.

REFERENCE

- [1] B. Jeppsson and P. Jeppesen, "A high power LSA relaxation oscillator", Proc. IEEE (Letters), vol. 57, June 1969.

Fig. 1 X-band waveguide iris circuit

Fig. 2a) Transmission line equivalent diagram
2b) Representation of total diode load impedance

Fig. 3 Frequency dependence of total diode load impedance

Fig. 4 Device voltage waveshape from computer simulation

Fig. 5 Simple LSA relaxation oscillator